UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/551,740	09/30/2005	Alexander Ralph Beeck	2002P19478WOUS	4282	
28524 7590 03/16/2010 SIEMENS CORPORATION INTELLECTUAL PROPERTY DEPARTMENT 170 WOOD AVENUE SOUTH			EXAMINER		
			SANDERS, JAMES M		
ISELIN, NJ 088			ART UNIT	PAPER NUMBER	
			1791		
			MAIL DATE	DELIVERY MODE	
			03/16/2010	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)	
10/551,740	BEECK ET AL.	
Examiner	Art Unit	

		OF TIMES OF TIMES	1731	
	The MAILING DATE of this communication appe	ears on the cover sheet with the c	correspondence address	
THE R	EPLY FILED <u>09 March 2010</u> FAILS TO PLACE THIS AF	PPLICATION IN CONDITION FOR	ALLOWANCE.	
a fo	The reply was filed after a final rejection, but prior to or on pplication, applicant must timely file one of the following pplication in condition for allowance; (2) a Notice of Appeter Continued Examination (RCE) in compliance with 37 Ceriods:	replies: (1) an amendment, affidavi eal (with appeal fee) in compliance	it, or other evidence, which places the with 37 CFR 41.31; or (3) a Request	9
	The period for reply expiresmonths from the mailing	-		
b) 🖸	no event, however, will the statutory period for reply expire to Examiner Note: If box 1 is checked, check either box (a) or (ater than SIX MONTHS from the mailing (b). ONLY CHECK BOX (b) WHEN THE	g date of the final rejection.	
have be under 3 set forth may red	MONTHS OF THE FINAL REJECTION. See MPEP 706.07(cons of time may be obtained under 37 CFR 1.136(a). The date ten filed is the date for purposes of determining the period of exity 7 CFR 1.17(a) is calculated from: (1) the expiration date of the solin (b) above, if checked. Any reply received by the Office later luce any earned patent term adjustment. See 37 CFR 1.704(b). E OF APPEAL	on which the petition under 37 CFR 1.1 tension and the corresponding amount shortened statutory period for reply origing than three months after the mailing data	of the fee. The appropriate extension fee inally set in the final Office action; or (2) as	s
	he Notice of Appeal was filed on A brief in comp	liance with 37 CFR 41.37 must be	filed within two months of the date of	
fi N	ling the Notice of Appeal (37 CFR 41.37(a)), or any exter lotice of Appeal has been filed, any reply must be filed w DMENTS	nsion thereof (37 CFR 41.37(e)), to	avoid dismissal of the appeal. Since	
(The proposed amendment(s) filed after a final rejection, by They raise new issues that would require further core. They raise the issue of new matter (see NOTE belo	nsideration and/or search (see NO		
(c) They are not deemed to place the application in bet appeal; and/or d) They present additional claims without canceling a	ter form for appeal by materially red		
(,	NOTE: (See 37 CFR 1.116 and 41.33(a)).		ected claims.	
4. 🔲	The amendments are not in compliance with 37 CFR 1.12		mpliant Amendment (PTOL-324).	
	Applicant's reply has overcome the following rejection(s):		,	
6. 🔲 — ⁿ	Newly proposed or amended claim(s) would be all on-allowable claim(s).	lowable if submitted in a separate,		!
h T C C	For purposes of appeal, the proposed amendment(s): a) ow the new or amended claims would be rejected is provine status of the claim(s) is (or will be) as follows: Claim(s) allowed: Claim(s) objected to: Claim(s) rejected: Claim(s) withdrawn from consideration:		ll be entered and an explanation of	
	AVIT OR OTHER EVIDENCE			
b	he affidavit or other evidence filed after a final action, bu ecause applicant failed to provide a showing of good and as not earlier presented. See 37 CFR 1.116(e).	t before or on the date of filing a No d sufficient reasons why the affidav	otice of Appeal will <u>not</u> be entered it or other evidence is necessary and	
е	he affidavit or other evidence filed after the date of filing ntered because the affidavit or other evidence failed to o howing a good and sufficient reasons why it is necessary	vercome <u>all</u> rejections under appea	al and/or appellant fails to provide a	
	The affidavit or other evidence is entered. An explanation EST FOR RECONSIDERATION/OTHER	n of the status of the claims after e	ntry is below or attached.	
	The request for reconsideration has been considered bu See Continuation Sheet.	t does NOT place the application in	n condition for allowance because:	
	Note the attached Information <i>Disclosure Statement</i> (s). (Other:	(PTO/SB/08) Paper No(s)		
	eph S. Del Sole/ rvisory Patent Examiner, Art Unit 1791			

Continuation of 11. does NOT place the application in condition for allowance because: Applicant asserts that on the one hand, the Examiner has conceded that Deckard fails to disclose a first and second powder mix differing from each other in chemical composition or powder particle size distribution (Office Action, p. 3), and cited to Sachs et al. as providing this noted deficiency, namely, "the first and second powder mixes differing from each other in at least one of chemical composition and powder particle size distribution" (Office Action, p.3); on the other hand, the Examiner somehow rejects that the teaching of Sachs et al. implementing this modification (of layering the first and second powder mixes with the dispersion head and binder material) would even be implemented in the modified Deckard. Such inconsistent reasoning underscores the fundamental unsoundness of the Examiner's reasoning and the modified version of Deckard would render Deckard unsatistactory tor its intended purpose and would not involve the use of a laser sintering process, and thus the rejection of independent claim 17 is fatally deficient. Examiner, however, maintains, as cited in the rejection of claim 17, that Sachs et al. teach a second powder mix in a second region, the first and second powder mixes differing from each other in at least one of chemical composition and powder particle size distribution and the combination of the Deckard reference is with only this element of and not the whole of the Sachs et al. reference and there is no teaching away involved with this element, and thus would not render Deckard unsatisfactory for its intended purpose.

Applicant further asserts that Examiner mischaracterizes the Deckard and Sachs et al. references, presuming that one of ordinary skill in the art would somehow develop a method of: (1) applying a layer of first and second powder from a first and second dispersion head, and (2) use the laser 12 of Deckard in some fashion with these applied powder layers. Neither Deckard nor Sachs et al. teaches any such arrangement or method. As discussed above, the only layering method of powder involving the application of powder from the dispersion head also involves a successive application of a binder material in between the successive layers, and thus, there is insufficient teaching as to why one of ordinary skill in the art would unnecessarily use the laser 12 to form layers in the powder, when the dispersion head/binder material process has already formed layers. Examiner, however, points out that a fundamental concept of Deckard is the build up of a part in a layer-by-layer manner, and Deckard teaches a portion of powder 22 is deposited in the target area 26 and selectively sintered by the laser beam 64 to produce a sintered layer (cl 5 lns 55-67). Further, the powder dispenser 14 is supplied by a hopper 20 (cl 4 lns 40-41). Since Sachs et al. teaches that the first and second powders are individually applied from separate dispersion heads, another dispersion head would be added for the second powder. Clearly, one of ordinary skill would also, while depositing the first and second powders of a layer, move the dispersion heads in such a way so as not to interfere with the performance of the laser, optics, and thus the sintering process.

Finally, Applicant asserts that Lewis et al. merely discloses a melting process, and thus teaches away from a sintering process, which is a method for making objects from powder by heating the powder to below its melting point until the particles adhere to each other and Examiner merely pointed to a teaching of Lewis et al., which discloses that varying laser power causes less melting, which in-turn reduces density and stated that it is inherent that powder particles not melted adhere to each other. This teaching provides no basis in fact or reasonable support for the Examiner's inherency claim and neither Lewis et al., nor any cited prior art reference, alone or in combination, discloses that the respective first/second laser sintering is controlled to provide different material properties in the first and second regions of the shaped object, as recited in independent claim 17. Examiner, however, maintains that incomplete melting is equivalent to sintering and points out that there at least two types of sintering: solid state sintering is a method for making objects from powder by heating the material below its melting point and liquid state sintering is a method in which at least one but not all of the elements exist in a liquid state. Examiner finds no where in claim 17 that it is limited to only solid state sintering. Further, Lewis et al. teach controlling a laser beam generated during the first and second laser sintering processes to produce a different sintering temperature over the first and second regions of the object creating a different degree of densification in the first and second regions of the shaped object. (cl 22 lns 1-5 i.e. An article whose density varies, that is, has different densities at different locations, may be formed by varying laser power...Decreasing laser power results in less melting of the powder, thus reducing density).